PTO/SB/01 (6/95)	DECLARATION	Attorney Docket No. 8107-1 (S03US00
TPE AS A BELOV	W NAMED INVENTOR, I hereby declare that:	
2 0 2004 My residence	, post office address and citizenship are as stated next to m	y name.
Isbelieve that plural names are listed	I am the original, first and sole (if only one name is listed be d below), of the subject matter which is claimed and for which	elow), or an original, first and joint inventor (ich a patent is sought on the invention entitle
TITLE: MET	HOD FOR OVERLAY MEASUREMENT IN EXPOSU	IRE PROCESS
the specification of wh	nich either is attached hereto or indicates an attorney docke	et no. <u>8107-1 (S03US005)</u> , or:
was filed in the U.	S. Patent & Trademark Office on 12/29/03 and	assigned Serial No. 10/748,855
and (if applicable,	was amended on	
as amended by any a patentability and to the hereby claim foreign p inventor's certificate, of States, listed below an	that I have reviewed and understand the contents of the above mendment referred to above. I acknowledge the duty of examination of this application in accordance with Title 3 riority benefits under Title 35, U.S. Code §119(a)-(d) or §3 or §365(a) of any PCT international application which design dhave also identified below any foreign applications for particular on which priority is claimed:	to disclose information which is material to 7 of the Code of Federal Regulations §1.56. 65(b) of any foreign application(s) for patent on the distribution of the United at least one country other than the United.
2003-1342	KOREA	9 January 2003
(Application Number)	(Country)	(Day/Month/Year filed
(Application Number)	(Country)	(Day/Month/Year filea
States provisional appl	the benefit under Title 35, U.S. Code, §120 of any United lication(s), or §365(c) of any PCT International application	designating the United States, listed below a

ite insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PC International application(s) in the manner provided by the first paragraph of Title 35, U.S. Code, §112, I acknowledge the duty t disclose information material to patentability as defined in Title 37, The Code of Federal Regulations, §1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial Number)

(Filing Date)

(STATUS: patented, pending, abandoned)

I hereby appoint the following attorneys: FRANK CHAU, Reg. No. 34,136; FRANK V. DeROSA, Reg. No. 43,584; NATHANIEL T. WALLACE, Reg. No. 48,909; ERIC M. PARHAM, Reg. No. 45,747; THOMAS W. McNALLY Reg. No. 48,609; MICHAEL F. MORANO, Reg. No. 44,952; KOON H. WONG, Reg. No. 48,459; and BENJAMIN M. HALPERN, Reg. No. 46,434; and each of them of F. CHAU & ASSOCIATES, LLP, 1900 Hempstead Turnpike, Suite 501 East Meadow, New York 11554 to prosecute this application and to transact all business in the U.S. Patent and Trademark Offic connected therewith and with any divisional, continuation, continuation-in-part, reissue or re-examination application, with fu power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issu thereon, and request that all correspondence be addressed to:

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I HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on informatic and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements an the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 U.S. Code and that such willful fals statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF FIRS	ST OR SOLE INVENTOR: Sang-Il HAN	Citizenship: KOREA
Inventor's signature:	Sang-il-Han	Date: 2004.1.12
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